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** CONTINUING DATA *****

None SJ L

** FOREIGN APPLICATIONS *****

JAPAN 2002-240082 08/21/2002 SJ L

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| Foreign Priority claimed | <input checked="" type="checkbox"/> yes <input type="checkbox"/> no | STATE OR COUNTRY | SHEETS | TOTAL | INDEPENDENT |
|---------------------------------|---|---------------------|--------|-------|-------------|
| 35 USC 119 (a-d) conditions met | <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance | JAPAN | 16 | 21 | 5 |
| Verified and Acknowledged | <i>SJ L</i> Examiner's Signature Initials | | | | |

ADDRESS

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TITLE

Resist pattern thickening material, process for forming resist pattern, and process for manufacturing semiconductor device

FILING FEE FEES: Authority has been given in Paper

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|---|
| <input type="checkbox"/> All Fees |
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